74LVT125; 74LVTH125

3.3 V quad buffer; 3-state

Rev. 8 — 18 August 2021 Product data sheet

1. General description

The 74LVT125; 74LVTH125 is a quad buffer/line driver with 3-state outputs controlled by the output enable inputs (n$\overline{OE}$). A HIGH on n$\overline{OE}$ causes the outputs to assume a high impedance OFF-state. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs. This device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Quad bus interface
- 3-state buffers
- Wide supply voltage range from 2.7 to 3.6 V
- BiCMOS high speed and output drive
- Output capability: +64 mA and -32 mA
- Direct interface with TTL levels
- Overvoltage tolerant inputs to 5.5 V
- Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- No bus current loading when output is tied to 5 V bus
- Power-up 3-state
- I_{OFF} circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 500 mA per JESD 78 Class II Level B
- Complies with JEDEC standard JESD8C (2.7 V to 3.6 V)
- ESD protection:
  - HBM EIA/JESD22-A114-A exceeds 2000V
  - MM EIA/JESD22-A115-A exceeds 200V
- Specified from -40 °C to 85 °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVT125D	-40 °C to +85 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74LVTH125D				
74LVT125PW	-40 °C to +85 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74LVTH125PW				
74LVT125BQ	-40 °C to +85 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	SOT762-1
74LVTH125BQ				

4. Functional diagram

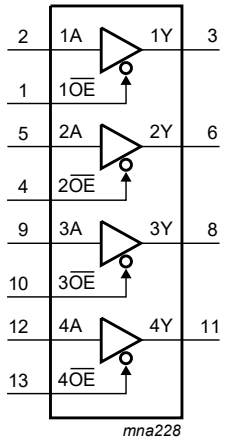


Fig. 1. Logic symbol

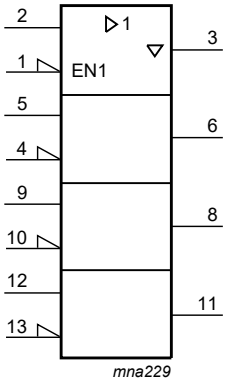


Fig. 2. IEC logic symbol

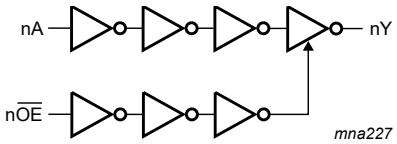


Fig. 3. Logic diagram (one buffer)

5. Pinning information

5.1. Pinning

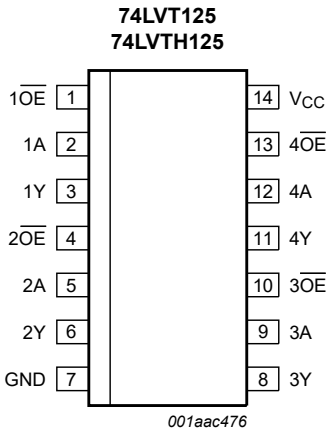
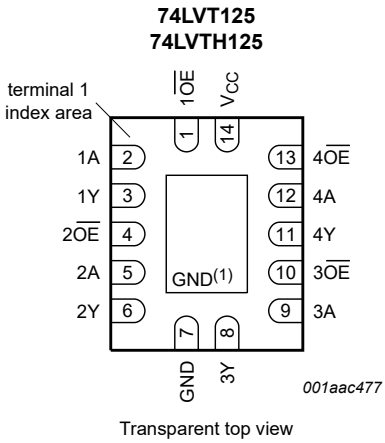


Fig. 4. Pin configuration SOT108-1 (SO14) and SOT402-1 (TSSOP14)



Transparent top view

(1) This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

Fig. 5. Pin configuration SOT762-1 (DHVQFN14)

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
$1\overline{OE}$	1	1 output enable input (active LOW)
1A	2	1 data input
1Y	3	1 data output
$2\overline{OE}$	4	2 output enable input (active LOW)
2A	5	2 data input
2Y	6	2 data output
GND	7	ground (0 V)
3Y	8	3 data output
3A	9	3 data input
$3\overline{OE}$	10	3 output enable input (active LOW)
4Y	11	4 data output
4A	12	4 data input
$4\overline{OE}$	13	4 output enable input (active LOW)
V_{CC}	14	supply voltage

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Control	Input	Output
$n\overline{OE}$	**nA**	**nY**
L	L	L
L	H	H
H	X	Z

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
V_I	input voltage	[1]	-0.5	+7.0	V
V_O	output voltage	output in OFF-state or HIGH-state [1]	-0.5	+7.0	V
I_{IK}	input clamping current	V_I < 0 V	-	-50	mA
I_{OK}	output clamping current	V_O < 0 V	-	-50	mA
I_O	output current	output in LOW-state	-	128	mA
		output in HIGH-state	-	-64	mA
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature	[2]	-	150	°C

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		2.7	-	3.6	V
V_I	input voltage		0	-	5.5	V
V_{IH}	HIGH-level input voltage		2.0	-	-	V
V_{IL}	LOW-level input voltage		-	-	0.8	V
I_{OH}	HIGH-level output current		-	-	-32	mA
I_{OL}	LOW-level output current	none	-	-	32	mA
		current duty cycle ≤ 50 %;f ≥ 1 kHz	-	-	64	mA
Δt/ΔV	input transition rise and fall rate		0	-	10	ns/V
T_{amb}	ambient temperature	in free air	-40	-	+85	°C

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
T_{amb} = -40 °C to +85 °C						
V_{IK}	input clamping voltage	I_{IK} = -18 mA; V_{CC} = 2.7 V	-	-0.9	-1.2	V
V_{OH}	HIGH-level output voltage	I_{OH} = -100 µA; V_{CC} = 2.7 V to 3.6 V	V_{CC} - 0.2	V_{CC} - 0.1	-	V
		I_{OH} = -8 mA; V_{CC} = 2.7 V	2.4	2.5	-	V
		I_{OH} = -32 mA; V_{CC} = 3.0 V	2.0	2.2	-	V

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
V_{OL}	LOW-level output voltage	V_{CC} = 2.7 V				
		I_{OL} = 100 µA	-	0.1	0.2	V
		I_{OL} = 24 mA	-	0.3	0.5	V
		V_{CC} = 3.0 V				
		I_{OL} = 16 mA	-	0.25	0.4	V
		I_{OL} = 32 mA	-	0.3	0.5	V
		I_{OL} = 64 mA	-	0.4	0.55	V
I_I	input leakage current	all input pins				
		V_{CC} = 0 V or 3.6 V; V_I = 5.5 V	-	1	10	µA
		control pins				
		V_{CC} = 3.6 V; V_I = V_{CC} or GND	-	±0.1	±1	µA
		data pins [2]				
		V_{CC} = 3.6 V; V_I = V_{CC}	-	0.1	1	µA
		V_{CC} = 3.6 V; V_I = 0 V	-	-1	-5	µA
I_{OFF}	power-off leakage current	V_{CC} = 0 V; V_I or V_O = 0 V to 4.5 V	-	1	±100	µA
I_{BHL}	bus hold LOW current	V_{CC} = 3 V; V_I = 0.8 V [3]	75	150	-	µA
I_{BHH}	bus hold HIGH current	V_{CC} = 3 V; V_I = 2.0 V	-	-150	-75	µA
I_{BHLO}	bus hold LOW overdrive current	V_{CC} = 3.6 V; V_I = 0 V to 3.6 V	500	-	-	µA
I_{BHHO}	bus hold HIGH overdrive current	V_{CC} = 3.6 V; V_I = 0 V to 3.6 V	-	-	-500	µA
I_{LO}	output leakage current	output in HIGH-state when V_O > V_{CC}; V_O = 5.5 V; V_{CC} = 3.0 V	-	60	125	µA
$I_{O(pu/pd)}$	power-up/power-down output current	V_{CC} ≤ 1.2 V; V_O = 0.5 V to V_{CC}; V_I = GND or V_{CC}; n$\overline{OE}$ = don't care [4]	-	±1	±100	µA
I_{OZ}	OFF-state output current	V_{CC} = 3.6 V; V_I = V_{IH} or V_{IL}				
		output HIGH: V_O = 3.0 V	-	1	5	µA
		output LOW: V_O = 0.5 V	-	-1	-5	µA
I_{CC}	supply current	V_{CC} = 3.6 V; V_I = GND or V_{CC}; I_O = 0 A				
		outputs HIGH	-	0.13	0.19	mA
		outputs LOW	-	2	7	mA
		outputs disabled [5]	-	0.13	0.19	mA
ΔI_{CC}	additional supply current	per input pin; V_{CC} = 3 V to 3.6 V; one input at V_{CC} - 0.6 V and other inputs at V_{CC} or GND [6]	-	0.1	0.2	mA
C_I	input capacitance	V_I = 0 V or 3.0 V	-	4	-	pF
C_O	output capacitance	outputs disabled; V_O = 0 V or 3.0 V	-	8	-	pF

[1] Typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.
[2] Unused pins at V_{CC} or GND.
[3] This is the bus hold overdrive current required to force the input to the opposite logic state.
[4] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms.
From V_{CC} = 1.2 V to V_{CC} = 3.0 V to 3.6 V a transition time of 100 µs is permitted. This parameter is valid for T_{amb} = 25 °C only.
[5] I_{CC} is measured with outputs pulled to V_{CC} or GND.
[6] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.

10. Dynamic characteristics

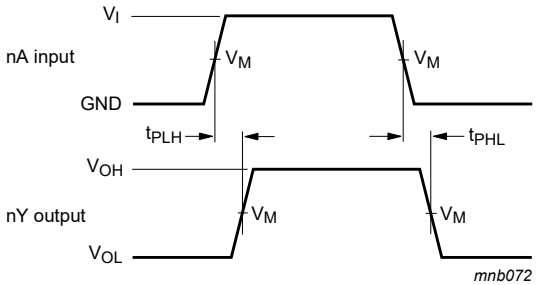
Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8.

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
T_{amb} = -40 °C to +85 °C						
t_{PLH}	LOW to HIGH propagation delay	nAn to nY; see Fig. 6				
		V_{CC} = 2.7 V	-	-	4.5	ns
		V_{CC} = 3.0 V to 3.6 V	1.0	2.7	4.0	ns
t_{PHL}	HIGH to LOW propagation delay	nAn to nY; see Fig. 6				
		V_{CC} = 2.7 V	-	-	4.9	ns
		V_{CC} = 3.0 V to 3.6 V	1.0	2.9	3.9	ns
t_{PZH}	OFF-state to HIGH propagation delay	$n\overline{OE}$ to nY; see Fig. 7				
		V_{CC} = 2.7 V	-	-	6.0	ns
		V_{CC} = 3.0 V to 3.6 V	1.0	3.4	4.7	ns
t_{PZL}	OFF-state to LOW propagation delay	$n\overline{OE}$ to nY; see Fig. 7				
		V_{CC} = 2.7 V	-	-	6.5	ns
		V_{CC} = 3.0 V to 3.6 V	1.1	3.4	4.7	ns
t_{PHZ}	HIGH to OFF-state propagation delay	$n\overline{OE}$ to nY; see Fig. 7				
		V_{CC} = 2.7 V	-	-	5.7	ns
		V_{CC} = 3.0 V to 3.6 V	1.8	3.7	5.1	ns
t_{PLZ}	LOW to OFF-state propagation delay	$n\overline{OE}$ to nY; see Fig. 7				
		V_{CC} = 2.7 V	-	-	4.0	ns
		V_{CC} = 3.0 V to 3.6 V	1.3	2.6	4.5	ns

[1] Typical values are at V_{CC} = 3.3 V and T_{amb} = 25 °C.

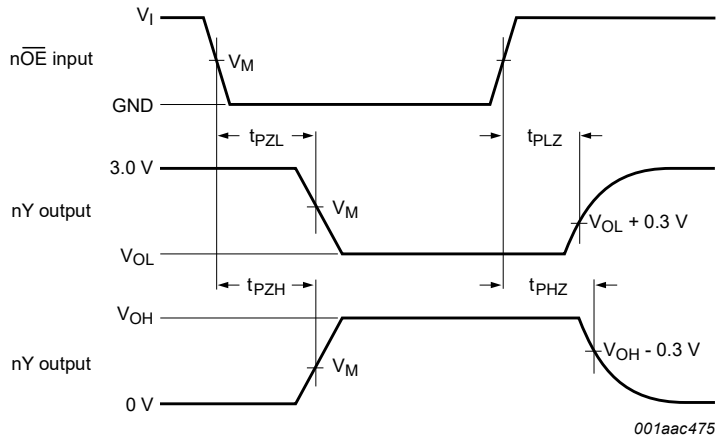
10.1. Waveforms and test circuit



V_M = 1.5 V.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

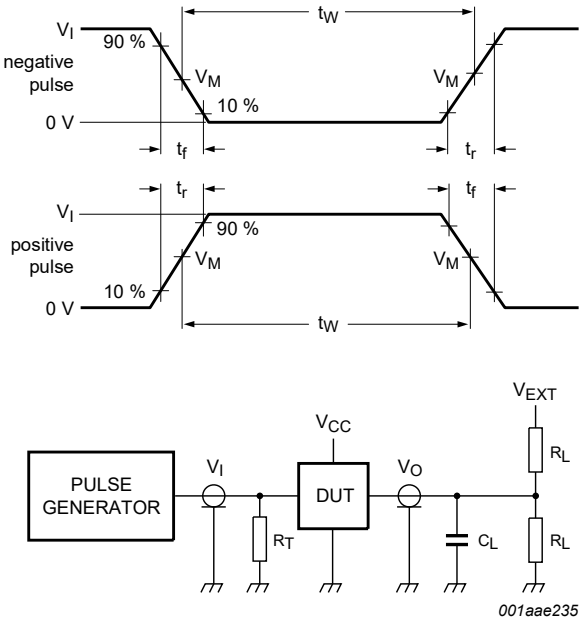
Fig. 6. Propagation delay input (nA) to output (nY)



V_M = 1.5 V.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 7. Enable and disable times of 3-state outputs



Test data is given in Table 8.

Definitions test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

V_{EXT} = Test voltage for switching times.

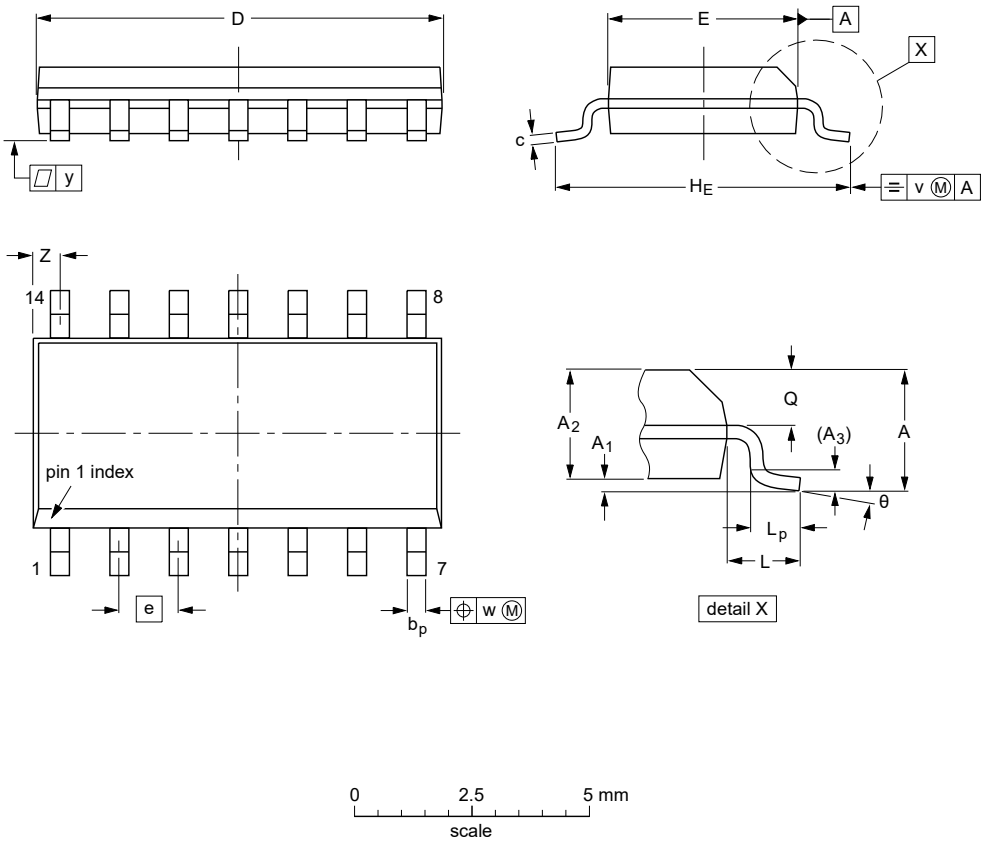
Fig. 8. Test circuit for measuring switching times

Table 8. Test data

Input				Load		V_{EXT}		
V_I	f_i	t_W	t_r, t_f	C_L	R_L	t_{PHZ}, t_{PZH}	t_{PLZ}, t_{PZL}	t_{PLH}, t_{PHL}
2.7 V	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V	open

11. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm **SOT108-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8^o 0^o
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

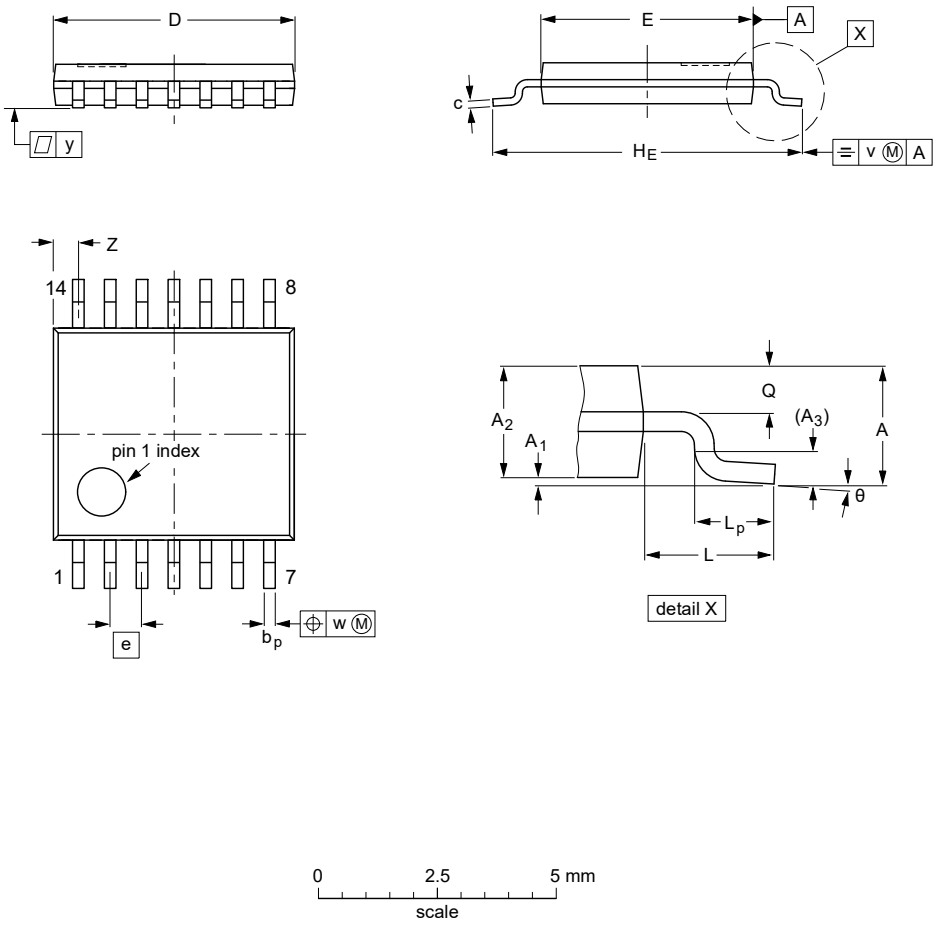
Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT108-1	076E06	MS-012				~~99-12-27~~ 03-02-19

Fig. 9. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm **SOT402-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (2)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

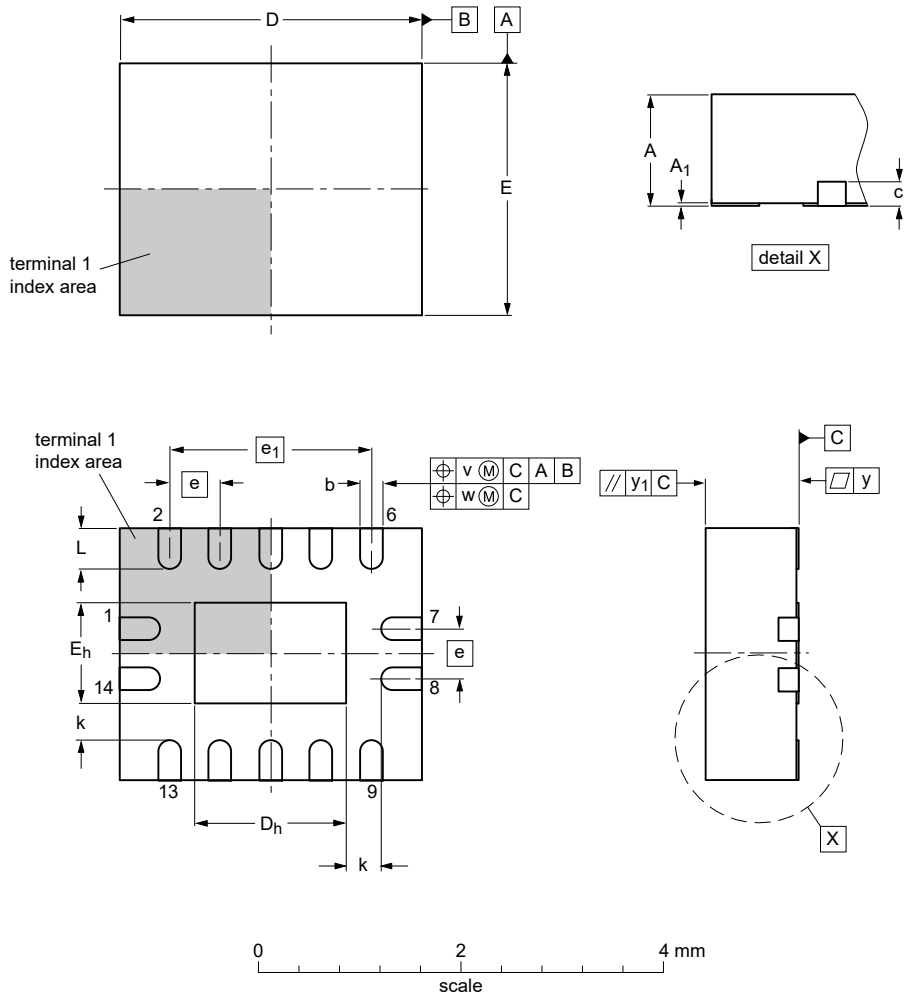
Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT402-1		MO-153				~~99-12-27~~ 03-02-18

Fig. 10. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm **SOT762-1**



Dimensions (mm are the original dimensions)

Unit		$A^{(1)}$	A_1	b	c	$D^{(1)}$	D_h	$E^{(1)}$	E_h	e	e_1	k	L	v	w	y	y_1
	max	1	0.05	0.30		3.1	1.65	2.6	1.15				0.5				
mm	nom		0.02	0.25	0.2	3.0	1.50	2.5	1.00	0.5	2		0.4	0.1	0.05	0.05	0.1
	min		0.00	0.18		2.9	1.35	2.4	0.85			0.2	0.3				

Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

sot762-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT762-1		MO-241				~~15-04-10~~ 15-05-05

Fig. 11. Package outline SOT762-1 (DHVQFN14)

12. Abbreviations

Table 9. Abbreviations

Acronym	Description
BiCMOS	Bipolar Complementary Metal Oxide Semiconductor
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVT_LVTH125 v.8	20210818	Product data sheet	-	74LVT_LVTH125 v.7
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Type numbers 74LVT125DB and 74LVTH125DB (SOT337-1/SSOP14) removed. • Section 1 and Section 2 updated. • Fig. 7 aligned with test conditions (errata).			
74LVT_LVTH125 v.7	20160531	Product data sheet	-	74LVT125 v.6
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate.			
74LVT_LVTH125 v.6	20060306	Product data sheet	-	74LVT125 v.5
Modifications:	• Section 3: Added type numbers 74LVTH125D, 74LVTH125DB, 74LVTH125PW and 74LVTH125BQ.			
74LVT125 v.5	20050210	Product data sheet	-	74LVT125 v.4
74LVT125 v.4	20050207	Product data sheet	-	74LVT125 v.3
74LVT125 v.3	20040624	Product data sheet	-	74LVT125 v.2
74LVT125 v.2	19980219	Product specification	-	74LVT125 v.1
74LVT125 v.1	-	-	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at

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